

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t3512mpms#pbf

(Engineering Calculation)

MSOP with 4 PINS REMOVED

(printed on: 2020-07-11 16:46:34)

**TOTAL MASS (g) : 0.039077**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003694	1000000	94531.2421875		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.013845	975000	354300.25		
		Iron (Fe)	7439-89-6	0.000355	25000	9084.62109375		
		Phosphorus (P)	7723-14-0	0.000004	300	102.361938477		
		Zinc (Zn)	7440-66-6	0.000010	700	255.904830933		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.014214</b>	<b>1001000</b>	<b>363743.125</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	18169.8828125		
		<b>External Plating Total:</b>				<b>0.000710</b>	<b>1000000</b>	<b>18169.8828125</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	2200.78149414		
<b>Internal Plating Total:</b>				<b>0.000086</b>	<b>1000000</b>	<b>2200.78149414</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001075	750000	27509.7714844		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000358	250000	9161.39355469		
<b>Die Attach Total:</b>				<b>0.001433</b>	<b>1000000</b>	<b>36671.1601562</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.002439	130000	62415.1914062		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.015571	830000	398469.4375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000657	35000	16812.9492188		
		Carbon Black (C)	1333-86-4	0.000094	5000	2405.50561523		
		<b>Encapsulation Total:</b>				<b>0.018761</b>	<b>1000000</b>	<b>480103.0625</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000179	1000000	4580.69677734		
					<b>TOTAL MASS (g) :</b>	<b>0.039077</b>		